

## HONHEVER(HK)LIMITED

# SPECIFICATION

Product Name

# CRYSTAL RESONATOR

Туре

DSX321G

.....

Nominal Frequency

25.000MHz

Spec No.

1P225000BC0CK

If there is a change in this specifications, the specification number may be changed.

	RECEIPT
DATE	
RECEIVED	(signature) (name)



#### 1. ELECTRICAL CHARACTERISTICS

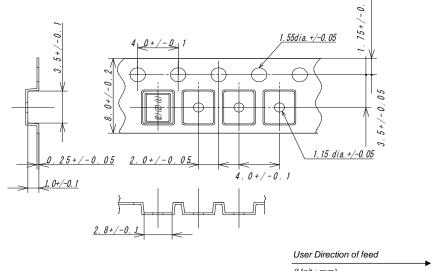
(This test shall be performed under the conditions of temp. at +25±3°C, Relative Humidity 60% max.)

(1) NOMINAL FREQUENCY	25.000 MHz		
(2) OVERTONE ORDER	Fundamental		
(3) LOAD CAPACITANCE(CL)	20.0 pF		
(4) FREQUENCY TOLERANCE	±20 ppm (at +25 ± 3 °C)		
(5) DRIVE LEVEL	10 ± 2 µW		
(6) SERIES RESISTANCE	60 $\Omega$ max. (at Series)		
(7) OPERATING TEMPERATURE RANGE	-40 ~ +85 °C		
(8) FREQUENCY CHARACTERISTICS OVER TEMPERATURE	±30 ppm / -40 ~ +85 °C	(ref. to	+25°C)
(9) SHUNT CAPACITANCE	2.0 pF max.		
(10) INSULATION RESISTANCE	500 M $\Omega$ min. / DC 100 ± 15V		
(11) STORAGE TEMPERATURE RANGE	-40 ~ +85 °C		
2. CONSTRUCTION (1) DIMENSIONS AND MARKING	Refer to 4.		
3. OTHER SPECIFICATIONS			
(1) EMBOSS CARRIER TAPE AND REEL	Refer to 5.		
(2) PACKING	Refer to 6.		
(3) REFLOW CONDITIONS (REFERENCE)	Refer to 7.		
(4) LAND PATTERN (REFERENCE)	Refer to 8.		
(5) RELIABILITY SPECIFICATION	Refer to 9.~11.		
(6) OTHER HANDLING INSTRUCTIONS	Refer to 12.		
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$\begin{split} \begin{array}{c} \\ \hline \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ $	
$\label{eq:response} \begin{array}{c} (\text{itermal connections}) \\ (\text{Top View}) \\ (\text{for View}) \\ (for V$	
$\begin{array}{c} & \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \$	
$\begin{aligned} &  \label{eq:production} \qquad \qquad$	
Figure-1       Figure-1         Logo(1) and Nominal Frequency (2) should be printed as follows by producing district         Made in CHINA      >         Spec. No.:       1P225000BC0CK         . Logo:       D         . Made in CHINA      >         Spec. No.:       1P225000BC0CK         . Logo:       D         . Made in CHINA      >         . Made in CHINA       : Top Bar with 25         . Made in CHINA       : Top Bar with 25         . Manufacturing lot No.(3)       (ex. 25.00         (war)       ex. 2021         . Mutracturing lot No.(3)       (Yeng)         (Month)       ex.         Now:       shall be marked as '       1         . (As shown in Table-1.)       (Month)         Table-1.)         Table-1.)         Table -1         Mark A B C         D         F         G         Table -1         Mark A B C         D         F         G         Mark A B C         D	
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Made in CHINA      >       Spec. No.:       1P225000BC0CK , Logo : D , Frequency: 25         * Made in CHINA       : Top Bar with 25         Nominal Frequency (2) = Mark two digits from upper decimal point (ex. 25.00 MHz> 25 )         Manufacturing lot No.(3) (year) ex. 2021 shall be marked as ' 1 ' (The last digit of the year) (Month) ex. Nov. shall be marked as ' L ' (As shown in Table-1.)         (Table-1.)         (Table-1.)         Mark two digits from upper decimal point (vear) (x 25.00 MHz> 25 )         Manufacturing lot No.(3) (year) ex. 2021 shall be marked as ' 1 ' (The last digit of the year) (Month) ex. Nov. shall be marked as ' L ' (As shown in Table-1.)         (Table-1.)         Mark two digits from upper decimal point (year) ex. 2021 shall be marked as ' L ' (As shown in Table-1.)         D E F G H J K L M	
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Month       Jan.       Feb.       Mar.       Apr.       May.       Jun.       Jul.       Aug.       Sep.       Oct.       Nov.       Dec.         Mark       A       B       C       D       E       F       G       H       J       K       L       M         Plating material of a terminal. : Ni Plating + Au Plating.       Plating.	
Plating material of a terminal. : Ni Plating + Au Plating.	
A clearance between the soldering terminal portion and a print circuit board side should be less than 0.1mm.	
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	AGE
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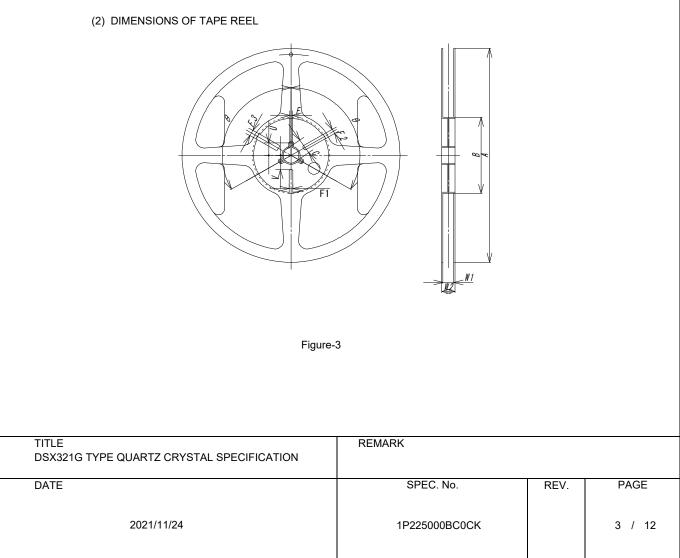
## 5. EMBOSS CARRIER TAPE AND REEL

#### (1) DIMENSIONS OF EMBOSSED CARRIER TAPE



(Unit : mm)

Figure-2



				(Unit:mm)
	ltem		Mark	Dimensions Angle
	Diameter		А	Ф180 +0.0 / -3.0
	Inside	of Flange	W1	9.0 ± 0.3
Flange	Outsid	e of Flange	W2	11.4 ± 1.0
	Inside	Diameter	В	Ф60 +1.0 / -0.0
	Angle	F1	3.0 ± 0.2	
Center Core		Width	F2	4.0 ± 0.2
			F3	5.0 ± 0.2
		Length	V	11.9 +0.5 / -0.0
		Angle	θ	120°
	Spindle Diameter		С	Φ13 ± 0.2
	Key Seats	Width	E	2.0 ± 0.5
		Length	U	10.5 ± 0.4
		Angle	θ	120°

(3) MATERIAL OF THE REEL

Reel	Polystyrene+Carbon(Black)
	Polystyrene(White)

(4) STORAGE CONDITION
 Temperature : +40°C max.
 Relative Humidity : 80% max.
 (It is a guaranteed term because it obtains an excellent soldering: 6months)

(5) STANDARD PACKING QUANTITY

3,000pcs/reel

(6) MATERIAL OF THE TAPE

Таре	Material
Carrier tape	Polystyrene+Carbon
Cover tape	Polyester

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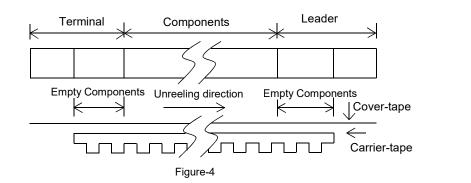
#### (7) LABEL CONTENTS

Type Our specification No. Your Part No. Lot No. Nominal Frequency Quantity Our Company Name Producting Country

Stick a label on the each reel.

#### (8) TAPING DIMENSION

	Cover-tape	The length of cover-tape in the leader is more than 400mm
Leader		including empty embossed area.
	Carrier-tape	After all products were packaged, must remain more than twenty pieces
		or 400mm empty area, which should be sealed by cover-tape.
	Cover-tape	The tip of cover-tape shall be fixed temporary by paper tape and roll around
Terminal		the core of reel one round.
	Carrier-tape	The empty embossed area which are sealed by cover-tape must remain
		more than 40mm.



(9) JOINT OF TAPE

The carrier-tape and cover-tape should not be jointed.

#### (10) RELEASE STRENGTH OF COVER TAPE

It has to between 0.1~0.7N under following condition.Pulling direction165~180°Speed300mm/minOtherwise unless specified.

165~180°	Pulling direction

Figure-5

Other standards shall be based on JIS C 0806 \_1990.

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## 6. PACKING

#### (1) STORAGE METHOD

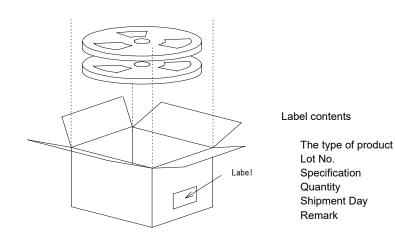


Figure-6

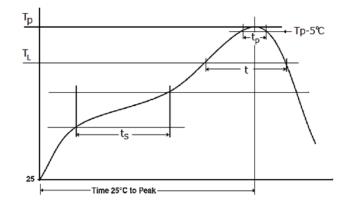
### (2) BOX SIZE

From lot size packingsize shall be changed. In the upper and lower part and the opening in box it shall be protected products using aircushion sheets.

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### 7. REFLOW CONDITIONS (REFERENCE)

During the solder reflow process, please complete within following temperature, period. Reflow soldering shall be allowed only 3times.



ts	(°C)	150~200
ts time	(s)	60~120
TL	(°C)	217
t time	(s)	60~150
Тр	(°C)	max. 260
tp	(s)	max. 30

Figure-7

8. LAND PATTERN (REFERENCE)

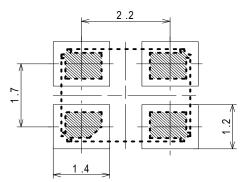


Figure-8

Unit : mm

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(55~2000Hz)

#### 9. MECHANICAL ENDURANCE

(1)	SHOCK	(ACCELERATION)	
	After the	following test, parts shall conform specific	ation 11.C
	1000m/s	<sup>2</sup> by 6ms X,Y,Z each axis (6directions), 10	)cycles

(2) SHOCK (MOUNTING DROP)

After the following test, parts shall conform specification 11.C

10cycles(60times) drop from 150cm heights to concrete. Further,parts shall be solderd on substrate, fixed Aluminum materials(about 100g).

- Substrate materials : FR-4, t=1.6mm
- 1cycle : each 1times of 6directions

#### (3) VIBRATION

After the following test, parts shall conform specification 11.C and no abnormal appearance shall be observed.

Frequency of Vibration	:	10~2000Hz
Amplitude(p-p)	:	Sine waves of 1.5mm (10~55Hz) and 200m/s <sup>2</sup>
Cycle	:	20min
Vibratian avia		V V 7

Vibration axis	-	Х, Ү, ∠
Vibration period	:	2h for each axis

#### (4) SEAL

Less than 1.0×10<sup>-9</sup>Pa·m<sup>3</sup>/s by Helium leak detector.

#### (5) SOLDERABILITY

After the following test, more than 90% of terminal shall be covered by new solder. 3±0.5s dip in +245±5°C solder. (Solder composition : Sn-3Ag-0.5Cu) (Use rosin type flux for solder.)

#### (6) RESISTANCE TO SOLDERING HEAT (REFLOW)

48h past at room temperature from following test, parts shall conform specification 11.D perform the attached Reflow conditions to reference.

#### (7) SUBSTRATE BENDING

After the following test, parts shall conform specification 11.C and no abnormality shall be observed in external appearance and sealing tightnen and others shall be based on ET-7403 of EIAJ.

Mount the specimen on substrate.

Apply the following pressure				20mm
Direction	:	see right figure		Zomini
Speed	:	about 1.0mm/s	Board (t=1.6mm)	Pressure jig
Hours	:	5±1s		R5
Amount of substrate	:	3mm max.		$\bigcirc$
Substrate materials	:	FR-4, t=1.6mm	<i>V</i>	1 I

45±2mm

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45±2mm

<ul> <li>(8) SHEAR <ul> <li>After the following test, parts shall conform spectand no abnormality shall be observed in externatightness and others shall be based on ET-7403</li> <li>Mount the specimen on substrate.</li> <li>Apply the following pressure</li> <li>Weight : 10N</li> <li>Hours : 10±1s</li> <li>Direction : see right figure</li> </ul> </li> </ul>	l appearance and sealing		ad (t=1.6mm)
(9) BODY STRENGTH After the following test, parts shall conform spect and no abnormality shall be observed in externation tests and others shall be based on ET-7403 Mount the specimen on substrate. Apply the following pressure Presure jig: R0.5 Weight : 1011 Mours : 10±13 Pressure Direction : see right figure	al appearance and sealing s of EIAJ.		L ↓ w
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#### 10. ENVIRONMENTAL ENDURANCE

(1) LOW TEMPERATURE

2h past at room temperature after following test, parts shall conform specification 11.D 240h, - $40\pm2^{\circ}C$ .

(2) HUMIDITY

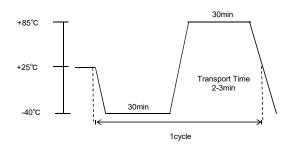
2h past at room temperature after following test, parts shall conform specification 11.D 240h, +85 $\pm$ 2°C, relative humidity 85 $\pm$ 5%.

(3) HIGH TEMPERATURE

2h past at room temperature after following test, parts shall conform specification 11.D 240h, +85 $\pm$ 2°C.

#### (4) TEMPERATURE CYCLE

2h past at room temperature after 200 cycles of following test, parts shall conform specification 11.D



#### 11. SPECIFICATION

Frequency Variation and Equivalent Resistance shall be within Table below after the reliability test.

Spec.	Spec. Frequency Variation Equivalent Resistance				
Α	A ±2ppm ±15% or ±2.0Ω (Use larger specification)				
В	B $\pm 5ppm$ $\pm 15\%$ or $\pm 2.0\Omega$ (Use larger specification)				
С	C ±5ppm ±20% or ±3.0Ω (Use larger specification)				
D	D $\pm 10$ ppm $\pm 20\%$ or $\pm 3.0\Omega$ (Use larger specification)				

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#### 12. DSX321G TYPE QUARTZ CRYSTAL HANDLING INSTRUCTIONS

#### (1) SOLDERING

Please perform the attached Reflow conditions to reference within 3times.

(2) MOUNT

Crystal products are designed to be compatible with automatic mounting. Be sure to have a mounting test in advance by using the actual mounting machine and check that the characteristics of the products are not damaged by the automatic mounting. In the process where the boad is warped, such as board separation process, be careful that the warping does not influence the characteristics and soldering of crystal products. Since mounting by Ultrasonic welding and processing have a possibility of an excessive vibration spreading inside a crystal resonator and becoming the cause of characteristic deterioration and not oscillating, it does not recommend. Underfilling Material for DSX321G Types, KDS considers underfilling material such as heat-cured resin would not affect the characteristics of the DSX321G crystal mounted, however, we recommend the crystal be tested and checked in such a case prior to use so that there are the possibility that the crystal may have a lid off or a crack in the ceramic base. (3) WASHING About use of the washing liquid of a basin system, an alcoholic system, and a chlorofluorocarbon-replacing material system, it is checking that it is satisfactory. However please consult in advance about other washing liquid. Although the check about ultrasonic washing is performed, since it is an examination with a crystal resonator simple substance, the check by the use state is recommended again. (4) THE CAUTIONS ON USE The piece of crystal it is processed very smaller than the conventional thing inside DSX321G series crystal unit may be damaged, if excessive excitation electric power is applied. Please use it below with the value specified on a catalog and specifications. Please refrain from forming patterns between crystal land pattern's since there is a possibility to cause crack in base. If the temperature is higher than +280°C, there is a possibility for the sealing glass to remelt. Avoid using the product at temperature higher than specified. (5) HANDLING OF A PRODUCT DSX321G series has sufficient intensity to fall and vibration. However when too much shock is added according to a certain cause, the use after a characteristic check is recommended.

#### (6) STORAGE

Since the soldering nature of a terminal may be degraded, please avoid storage in high temperature and a humid place. Please keep it in the place which direct rays do not hit and dew condensation does not generate.

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## 2021-0922 REVISION RECORD

Rev.No	Date	Reason	Contents	Approved	Checked	Drawn
-	2021/11/24	-	The first edition.	Y.Miura	S.Yamagata	M.Nagaishi

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